Fabrication of ZnO/Cu$_2$O heterojunctions in atmospheric conditions: Improved interface quality and solar cell performance

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ABSTRACT

Zn$_{1-x}$Mg$_x$O/Cu$_2$O heterojunctions were successfully fabricated in open-air at low temperatures via atmospheric atomic layer deposition of Zn$_{1-x}$Mg$_x$O on thermally oxidized cuprous oxide. Solar cells employing these heterojunctions demonstrated a power conversion efficiency exceeding 2.2% and an open-circuit voltage of 0.65 V. Surface oxidation of Cu$_2$O to CuO prior to and during Zn$_{1-x}$Mg$_x$O deposition was identified as the limiting factor to obtaining a high quality heterojunction interface. Optimization of deposition conditions to minimize Cu$_2$O surface oxidation led to improved device performance, tripling the open-circuit voltage and doubling the short-circuit current density. These values are the highest reported for a ZnO/Cu$_2$O interface formed in air, and highlight atmospheric ALD as a promising technique for inexpensive and scalable fabrication of ZnO/Cu$_2$O heterojunctions.

1. Introduction

Cuprous oxide (Cu$_2$O) has recently received increasing attention as a low-cost abundant photovoltaic material (Fig. 1). Cu$_2$O is a p-type semiconductor with a band gap of 2 eV and 23% theoretical efficiency limit [1]. However, the intrinsic nature of p-type conductivity in Cu$_2$O makes the formation of a homojunction, and hence achieving maximum efficiency, difficult [2]. Most of the research effort has therefore been focused on heterojunction solar cells, pairing Cu$_2$O with ZnO and its doped variations (see Table 1), although other wide band gap oxides such as In$_2$O$_3$:Sn (ITO), Ga$_2$O$_3$ and TiO$_2$ have been investigated as well [3,4]. Fig. 1 and Table 1 present developments in Cu$_2$O-based solar cell research over the past few years. One can note that the efficiencies and the open-circuit voltages of the devices have varied widely depending on the synthesis method used. In the most efficient cells, the p–n junction was formed by a vacuum-based technique such as pulsed laser deposition (PLD), atomic layer deposition (ALD) or sputtering. For low-cost photovoltaics, however, heterojunction synthesis outside a vacuum is preferable. Producing a good quality ZnO/Cu$_2$O interface in open-air at low temperature and in a scalable manner remains a challenge. This work therefore utilizes a vacuum-free scalable technique, atmospheric atomic layer deposition (AALD), for the deposition of polycrystalline ZnO and Mg:ZnO thin films on cuprous oxide, itself made at atmospheric pressure.

Atmospheric (or spatial) ALD separates precursors in space rather than in time (cf. conventional ALD) and hence allows for quicker deposition of conformal oxide films for low-cost solar cells in a manner compatible with roll-to-roll processing [5]. In this work, optimal AALD conditions for the deposition of Zn$_{1-x}$Mg$_x$O were identified, in order to preserve the pristine surface of the Cu$_2$O substrates and minimize the formation of phases detrimental to the heterojunction interface quality. When tested in solar cells, these optimizations resulted in a tripling of the open-circuit voltage ($V_{oc}$) and doubling of the short-circuit current density ($J_{sc}$), as well as an improved fill factor (FF), resulting in a six-fold increase in the power conversion efficiency (PCE) of the cells.

2. Experimental

2.1. Solar cell fabrication

Copper oxide substrates 13 mm × 13 mm × 170 μm were obtained by a 2 h oxidation of copper foil (0.127 μm thick, 99.9% pure, Alfa Aesar) at 1000 °C in an Ar–O$_2$ gas mixture, finished by quenching of the substrates from 500 °C in deionized water. The oxygen partial pressure was monitored throughout the heat treatment with a Rapidox 2100 Oxygen Gas Analyzer and was adjusted to approximately 10,000 ppm to keep the substrates in the phase region where cuprous oxide is thermodynamically stable. Cupric oxide formed on the substrate surface during quenching was removed by etching in dilute nitric acid [6], followed by sonication in isopropanol. Substrates...
were then masked on one side with insulating black paint, defining the solar cell area to be approximately 0.1 cm².

The zinc oxide and zinc magnesium oxide films were deposited using an Atmospheric ALD technique, similar to that described in [7]. Diethylzinc (DEZ) was used as the Zn precursor and bis(ethylcyclopentadienyl)magnesium as the Mg precursor. For zinc oxide deposition, the bubbling rate through the diethylzinc was 25 mL/min and the vapor was diluted with nitrogen carrier gas flowing at 100 mL/min. For zinc magnesium oxide deposition, the bubbling rate through the diethylzinc was 35 mL/min and the vapor was diluted with nitrogen carrier gas flowing at 200 mL/min. Nitrogen gas was bubbled at 100 mL/min through deionized water, which was employed as the oxidant. This vapor was diluted with carrier gas flowing at 200 mL/min. Nitrogen was also flowed at 500 mL/min through the four channels spatially separating the oxidant and metal precursor channels in the AALD gas manifold. The ZnO deposition rate was approximately 0.4 nm per second (or per cycle).

A 180 nm thick top electrode was sputtered on top of the Zn₁₋ₓMgₓO film from an ITO (10% SnO₂) target at the following conditions: power 20 W, base pressure < 10⁻⁹ mbar, Ar pressure 2.5 Pa, sputtering rate 35 nm/min, sputtering time 5 min. Fig. 2 shows a cross-sectional SEM image of the ITO and ZnO films deposited on a thermally oxidized Cu₂O substrate. An 80 nm gold bottom electrode was evaporated in an Edwards resistance evaporator (base pressure 8 × 10⁻⁶ mbar, rate 0.8 Å/s). For the optimized Zn₁₋ₓMgₓO/Cu₂O cells, the bottom electrode was evaporated before the formation of the p–n junction, as it was found that heating of the junction during evaporation leads to deteriorated performance. Top and bottom electrodes were contacted with Ag conductive paste for device testing.

2.2. Characterization

Surface and cross-sectional morphologies, as well as the composition of Cu₂O substrates and solar cells were analyzed using a LEO VP-1530 field emission scanning electron microscope with a built-in Oxford Instruments detector for energy-dispersive X-ray spectroscopy (EDX).

Copper oxide absorption was measured by photothermal deflection spectroscopy (PDS). PDS is a highly sensitive surface averaged absorption measurement technique capable of measuring absorption 5–6 orders of magnitude weaker than the band-edge absorption. Detailed description of the PDS technique can be found elsewhere [8]. In this work, freestanding Cu₂O samples were used for the PDS measurements.

Solar cells were tested under a simulated AM1.5G solar spectrum with the light intensity calibrated to 100 mW/cm² using a calibrated Si reference diode. The external quantum efficiency (EQE) of the cells was measured using a monochromator with a 100 W tungsten halogen lamp. The short-circuit current density obtained under the solar simulator was typically larger than the integrated short-circuit current density expected from the EQE measurements, which was attributed to different device performance with and without light soaking, underestimation of the device area, and spectral mismatch. To correct for this, all $J_{sc}$ were scaled by a factor of 0.74 so that the integrated $J_{sc}$ from the EQE and measured $J_{sc}$ were in agreement.

3. Results and discussion

3.1. Cu₂O surface instability

Thermally oxidized cuprous oxide is intrinsically unstable in air, always forming a thin CuO film on its surface [9,10]. It is evident from the Cu–O phase stability diagram that cupric oxide is
the stable phase at ambient conditions [11]. To probe the presence of CuO on Cu2O, as-oxidized and etched Cu2O substrates were examined with photothermal deflection spectroscopy (Fig. 3). The PDS absorption spectra for both substrates showed strong absorption at photon energies greater than \( \sim 2 \) eV, which is in agreement with the optical band gap of cuprous oxide. An absorption shoulder below the band gap (centered at \( \sim 1.6 \) eV) was present in both substrates. This shoulder can be attributed to the presence of cupric oxide (CuO), which has an optical band gap of approximately \( 1.4 \) eV [12]. The unetched Cu2O substrate had 10 times higher absorption in the 1.4–2 eV energy range than the etched substrate, implying a thicker CuO film on its surface, which was also confirmed visually as a grey semi-transparent film on the substrate. The fact that the freshly etched substrate also showed some absorption in this range suggests that a thin CuO film was still present on its surface when kept in ambient conditions, despite not being visually detectable.

The etched cuprous oxide surface was found to be compromised even further when heated in air, which is necessary for the deposition of ZnO by AALD. Fig. 4 shows SEM images of an etched Cu2O substrate surface before (a) and after (b) annealing in atmosphere at 150 °C for 3 min on the AALD platen under nitrogen flow, but without a metal precursor or oxidant supplied to the substrate. The annealing temperature and duration were selected to replicate standard conditions used for the deposition of ZnO by AALD. As can be seen in Fig. 4a, the etched Cu2O surface was visibly ‘clean’, i.e. free from \( \sim \) micron-sized second phases, featuring only the slip planes intersecting the surfaces of the differently oriented Cu2O grains. EDX analysis confirmed the chemical composition of the surface to be very close to that of Cu2O. However, after annealing (Fig. 4b), many micron-sized particles were found on the substrate surface. EDX analysis showed that the composition of these particles was close to that of CuO, while the composition of the adjacent substrate remained that of Cu2O. This suggests that cupric oxide growth is favored during the atmospheric deposition of metal oxides on a Cu2O surface.

Cupric oxide is an insulator and has a lower band gap (1.4 eV) than cuprous oxide (2 eV), which makes its presence undesirable for Cu2O photovoltaic applications: firstly, CuO absorbs radiation in the visible spectrum, thereby reducing the amount of photons reaching the Cu2O without contributing to the photocurrent. Secondly, the CuO conduction band, which is positioned approximately 4 eV below the vacuum level, introduces deep level trap states in the middle of the Cu2O band gap [9]. Cu2+ defect states coming from CuO may promote recombination detrimental to the device performance.

On the positive side, CuO can be removed in an oxygen-free environment (e.g. via ion etching) immediately before the deposition of the n-type oxide or a buffer layer. Also, very thin (\( \sim \) nm) CuO film can be passivated or reduced to Cu2O with a reactive metal oxide precursor such as diethylzinc when deposited by conventional ALD [9]. However, when producing the heterojunction outside a vacuum, it is more difficult to eliminate CuO from

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**Table 2**

<table>
<thead>
<tr>
<th>ZnO/Cu2O solar cell</th>
<th>ZnO Deposition temperature (°C)</th>
<th>ZnO Deposition time (s)</th>
<th>( J_{sc} ) (mA/cm²)</th>
<th>( V_{oc} ) (mV)</th>
<th>FF (%)</th>
<th>PCE (%)</th>
</tr>
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<tr>
<td>Standard</td>
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<td>0.18</td>
<td>35</td>
<td>0.23</td>
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<tr>
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<td>100</td>
<td>7.5</td>
<td>0.49</td>
<td>40</td>
<td>1.46</td>
</tr>
</tbody>
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Fig. 3. PDS spectra of etched and unetched (as-oxidized) Cu2O substrates.

Fig. 4. SEM images of etched Cu2O surface before (a), and (b) after annealing at 150 °C in air on the AALD platen. Multiple CuO formations can be seen on the surface in (b). Insets with EDX measurements show the composition of the selected areas.
the Cu2O surface. While thick CuO can be removed by grinding and polishing [13] or chemical wet etching [14], as soon as the underlying cuprous oxide is re-exposed to air, cupric oxide forms on the surface again [9]. Indeed, we confirmed this by the PDS spectrum of the freshly etched Cu2O substrate (Fig. 3). Therefore, in recognition of the chemical instability of Cu2O, adaptation of the atmospheric deposition conditions used to deposit the n-type semiconductor is necessary.

3.2. AALD ZnO deposition optimization

ZnO/Cu2O solar cells made with ZnO films deposited under standard ZnO AALD conditions (see Table 2 and Fig. 6, “standard”) exhibited poor performance as compared to the values reported in literature for cells made by other methods (Table 1). The low open-circuit voltage in these devices was attributed to the presence of CuO and other copper compounds between the Cu2O and ZnO layers. These undesirable phases can be seen as whisker- and flower-like formations in the SEM image of the surface of a standard ZnO/Cu2O solar cell (Fig. 5a). The image indicates that the CuO particles formed on the substrate surface during the AALD deposition remain underneath the ZnO film and hinder the formation of a proper ZnO/Cu2O heterojunction, significantly decreasing the attainable open-circuit voltage. Measures were therefore taken in order to minimize oxidation of the Cu2O substrate during the deposition of the ZnO. The time the substrates spent on the hot platen in air directly before, during and after the deposition was minimized. The deposition temperature was also reduced to decrease the diffusion rate of oxygen through the ZnO to the heterojunction and therefore the Cu2O oxidation rate. Additionally, in an attempt to reduce the surface CuO to Cu2O, the oxidant was introduced to the substrate only after a few cycles of metal precursor, as reported previously in [9].

To determine the optimum deposition temperature and time, ZnO was deposited for 40 s, 100 s, 200 s and 400 s at 150 °C and at 50, 75, 100 and 150 °C for 100 s. Fig. 7 shows the correlation of the open-circuit voltage with the duration of the deposition (a) and deposition temperature (b). It can be seen that Voc s tend to decrease towards higher deposition temperature and longer time. This is in agreement with Cu2O surface instability discussed earlier, since prolonged annealing in air at elevated temperature results in further oxidation of Cu2O to CuO. Similar findings were reported in literature, for example, Minami et al. have emphasized that to stabilize the Cu2O surface, a TCO has to be deposited as quickly as possible, preferably at room temperature and in a moisture- and oxygen-free environment [10]. Lee et al. have reported that a decrease in the ALD deposition temperature prevents Cu2O re-oxidation to CuO and facilitates the formation of a better quality heterojunction interface [9]. The lower Voc s observed in Fig. 7(b) for ZnO deposited at 50 °C may be explained by the platen temperature not being sufficiently high for precursors to react on the substrate surface, leading to the ZnO film having poorer carrier properties. The best ZnO/Cu2O solar cell was obtained with ZnO deposited at 100 °C for 100 s, and showed a 6-fold higher power conversion efficiency of 1.46% (see Figs. 1 and 6, Tables 1 and 2) for an optimized sample as compared to a standard ZnO/Cu2O device. This performance is comparable with the MgF2/ITO/ZnO/Cu2O solar cell reported by Mittiga et al. [6], who deposited ZnO by ion beam sputtering on thermally oxidized Cu2O. On the contrary, in this work, the heterojunction interface was formed outside a vacuum. The SEM image in Fig. 5b demonstrates that the optimized device surface was free of detrimental copper oxide compounds, in contrast to the device surface (Fig. 5a) formed using standard AALD ZnO deposition conditions which shows the presence of outgrowths (the ZnO conformally coats the Cu2O and so the ZnO surface morphology reflects the Cu2O morphology below).

3.3. External quantum efficiency measurements

To further investigate the effect of CuO formation on the quality of the heterojunction interface, external quantum efficiency measurements were performed. The Voc of the ZnO/Cu2O layers deposited under optimized and standard conditions is shown in Fig. 7. As the Voc is a key parameter for solar cell efficiency, these data show that the standard ZnO/Cu2O heterojunction suffers from a lower Voc compared to the optimized ZnO/Cu2O heterojunction, which has a Voc nearly 1 V higher than in the standard ZnO/Cu2O device. The Jsc and FF of the ZnO/Cu2O solar cells made using standard and optimized AALD conditions, measured at AM1.5g illumination (see Table 2).
measurements were performed on ZnO/Cu2O solar cells with ZnO deposited for 100 s at 100 °C and 150 °C. Since Cu2+ defects present at the heterojunction interface due to CuO formation may act as mid-bandgap recombination centers, it is expected that carriers generated close to the interface will be more likely to recombine in devices with more CuO formation. The absorption coefficient of Cu2O is such that radiation with a wavelength less than 475 nm is absorbed almost entirely within approximately 110 nm of the interface, whereas radiation of longer wavelengths ( > 475 nm) is absorbed further from the junction [15]. From the EQE spectra of the ZnO/Cu2O solar cells in Fig. 8 one can see that the EQE at wavelengths below 475 nm correlated with the open-circuit voltage of the devices. Lower carrier collection efficiencies (for charges generated near the interface) were measured for the cell with lower Voc. In contrast, the EQE at wavelengths above 475 nm was not dependent on the open-circuit voltage and instead was more affected by the bulk properties of Cu2O substrate. This is in agreement with our assertion that the low open-circuit voltage observed in these ZnO/Cu2O solar cells is a result of poor interface quality originating from the presence of CuO.

3.4. Mg incorporation into ZnO to further improve Voc

It has been previously demonstrated that incorporating Mg into ZnO improves the open-circuit voltage of ZnO/Cu2O solar cells [16]. The Mg raises the conduction band of ZnO, increasing the maximum built-in potential attainable for the ZnO/Cu2O heterojunction [17]. Raising the conduction band of ZnO can also increase Voc by reducing the conduction band offset, which reduces interfacial recombination [18]. Therefore, Mg was incorporated into ZnO by introducing Mg precursor during the AALD deposition to further improve the Voc. A solid solution with 21% Mg has been found to give the optimum balance between improved Voc and reduced conductivity [7]. Similarly, as in the case of the undoped ZnO, the AALD deposition conditions were optimized for zinc magnesium oxide, and are detailed in Table 3. It was found that the optimized Zn0.79Mg0.21/Cu2O solar cells exhibited improved performance, with PCEs exceeding 2% and open-circuit voltages of 0.65 V for the champion devices. Table 3 and Fig. 9 present the performance of the best devices made with unannealed Cu2O.

![Fig. 7. Open-circuit voltage plotted versus (a) time and (b) temperature of ZnO deposition. Error bars represent standard error of the mean.](image)

![Fig. 8. EQE spectra of ZnO/Cu2O solar cells with ZnO deposited at 100 °C and 150 °C, Voc indicated.](image)

![Fig. 9. Light J-V characteristics for the best optimized ITO/Zn0.79Mg0.21O/Cu2O solar cells.](image)

| Table 3 | Mg:ZnO AALD deposition parameters and performance of optimized ITO/Mg:ZnO/Cu2O solar cells. |
|---------------------------------|---------------------------------|---------------------------------|---------------------------------|---------------------------------|---------------------------------|---------------------------------|---------------------------------|---------------------------------|
| Zn0.79Mg0.21/Cu2O solar cell   | Deposition temperature (°C)   | Deposition time (s)       | Jsc (mA/cm²)    | Voc (V)       | FF (%)       | PCE (%)       |
| Optimized (annealed Cu2O)      | 150                           | 100                        | 6.9             | 0.65          | 49.2          | 2.2            |
| Optimized (unannealed Cu2O)    | 150                           | 100                        | 7.55            | 0.61          | 48.5          | 2.2            |
substrates, as well as substrates annealed at 1000 °C for 7 h at approximately 10,000 ppm oxygen partial pressure. This efficiency is the highest that has been reported for an ambient zinc oxide/cuprous oxide solar cell.

4. Conclusion

ZnO/Cu2O heterojunctions have been successfully fabricated in air at low temperatures through the deposition of Zn1−xMgxO by atmospheric ALD on thermally oxidized Cu2O. Oxidation of Cu2O to CuO prior to and during ZnO deposition was identified as the limiting factor to obtaining a high quality heterojunction interface. The presence of CuO led to a reduced open-circuit voltage due to the recombination at the Cu3+ interface defects. Optimization of the Zn1−xMgxO deposition conditions, including deposition temperature and time, in order to minimize substrate surface oxidation, led to a reduced amount of CuO at the Zn1−xMgxO/Cu2O interface, and to the tripling of the open-circuit voltage, doubling the recombination at the Cu2O interface, and to the tripling of the open-circuit voltage, doubling the recombination at the CuO/Cu2O heterojunction interface. 

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References


